



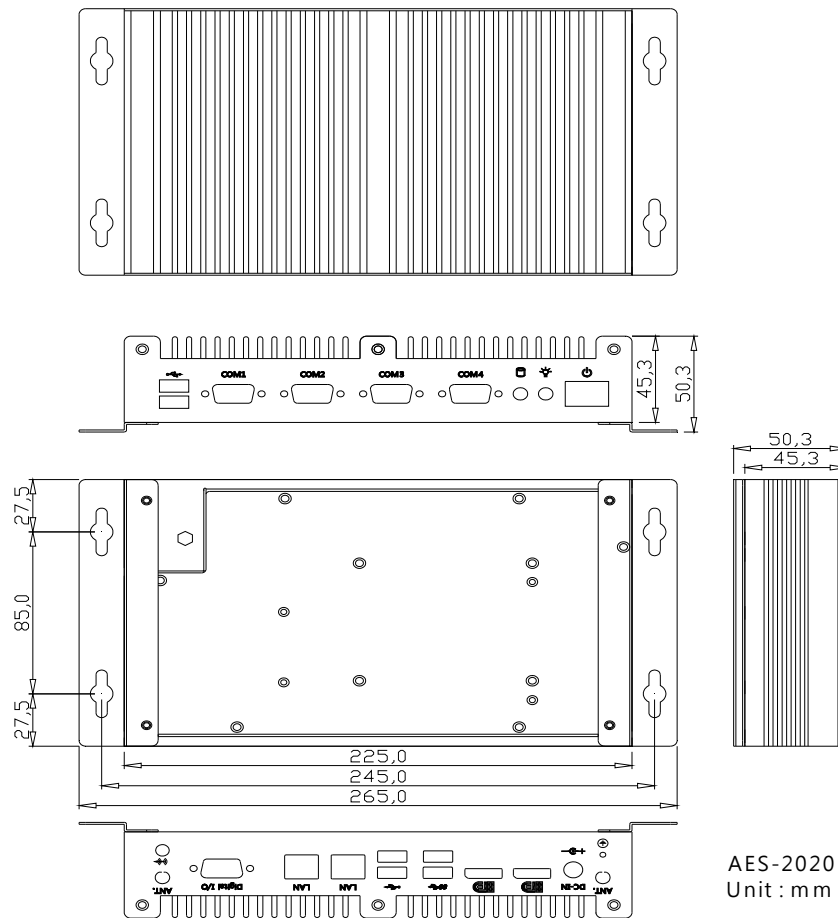
Features

- Support wide temperature -20°C ~ +70°C application with Intel 11th Elkhart Lake Atom x6425E QC, x6211E DC CPU
- Supports DDR4 3200MHz, 1xSO-DIMM, up to 32GB system memory
- 2 x DP++ Port, 2 x Intel 2.5GbE LAN, 2x USB 3.1, 4x USB 2.0
- 4x COM, COM2 by RS-485/422/232, COM1/3/4 by RS-232
- Onboard M.2 B/E-Key, Nano SIM card slot, option TPM 2.0
- DC 12V Input by DC-Jack
- Supports Microsoft Windows 10 IoT 64bit (Ent 2019 LTSC)
- Designed for extreme operating environment as outdoor applications

Specifications

AES-2360 Series Key Features		AES-2020M-M8N12DP0	AES-2020L-M8N12DP0
Processor System	CPU Max. Speed	Up 3.0GHz/2.0GHz	Up 3.0GHz/1.3GHz
	L2 Cache / Core	1.5MB, 4-Core	1.5MB, 2-Core
	CPU/ TDP	Atom x6425E / 12W	Atom x6211E / 6W
	BIOS	AMI SPI 256Mbit, XQ2.0	
Security	Graphics Processor	Intel UHD Graphics	
	TPM	fTPM(default), dTPM2.0(option)	
Expansion Slot	M.2 B-Key	1 x M.2 B-Key 2242/3042/2280 (PCIe x1/SATA 3.0/USB 2.0 and LTE module) Slot	
		1 x Nano SIM socket (connected to M.2 B key)	
	M.2 E-Key	1 x M.2 E-Key 2230(PCIe x1/USB 2.0) for Wireless	
Memory	Specification (SO-DIMM)	1 x DDR4 3200MHz SO-DIMM 8GB wide temperature (option up to 32GB)	
	System Max. Capacity	32GB	
Graphics	DP	2 x DP++, resolution up to 4096x2160 @ 60Hz	
Ethernet	LAN Gigabit Controller	2 x 2.5GbE LAN (Intel I225-LM / Intel I226-LM)	
Storage	M.2 B-Key	1 x M.2 B-Key 2280 128GB wide temperature (SATA 3.0)	
	2.5" SATA Driver	1 x 2.5" SATA HDD/SSD (option)	
System Rear I/O	DP	2 x DP++	
	Ethernet	2 x RJ45	
	USB Type A	2 x USB 3.2(Gen 2), 2 x USB 2.0	
	Audio	1 x Audio port (Line-out)	
	Digital I/O	1 x DB-9 female (8 x GPIO and GND)	
	System Power Input	1 x DC-in Jack 12Vdc Input (+/-10% DC)	
	Antenna	2 x Antenna holes (options)	
System Front Bezel	Power-On Button	1 x Moment button switch to turn-on system	
	System Power LED	1 x LED for system power status	
	HDD LED	1 x LED for SSD data access status	
	COM1 Port	1 x DB-9 (RS-232 with 5V/12V selectable)	
	COM2 Port	1 x DB-9 (RS-485/422/232)	
	COM3-4 Ports	2 x DB-9 (RS-232)	
	USB Type A	2 x USB 2.0	
Operation System	Customized LVDS Port	Customized LVDS feature for open frame LCD display by request	
	Windows 64-bit	Win 10 IoT 64-bit	
Watchdog Timer	Linux 64-bit	Ubuntu 19.04 / 20.04; Fedora 30; RHEL 7.6/8.0/8.2; SUSE Leap/SLES	
	Output and Interval	System reset, programmable 1 ~ 255 sec/min; 1 sec. or 1min. /step	
Power Requirement	DC Input	12Vdc input (option DC12V/5A 60W adapter)	
	Operating Temperature	-20°C ~ 70°C (-4°F ~ 158°F)	
Environment	Air Flow condition	70°C ~75°C (158°F ~140°F) w/0.7m/s air flow and by x64211E CPU	
	Storage Temperature	-40 ~ 85°C (-40 ~ 185°F)	
Physical Size	Dimensions	225mm(W) x 140mm(D) x 45mm(H)	
Packing Size	Dimensions	300mm(W) x 270mm(D) x 130mm(H)	
Weight	N.W / G.W.	Single packed: 2.5Kg / 3Kg	
Certifications	EMC	CE, FCC Class B	

Dimensions Outlook



Ordering Information

Part Number	CPU	DP	GbE	USB 3.1	USB 2.0	COM	DDR4 RAM (WT)	M.2 B-Key	60W PSU
AES-2020L-M8N12DP0	x6211E	2	2	2	4	4	8GB	128GB SATA3 TLC (WT)	Option
AES-2020M-M8N12DP0	x6425E	2	2	2	4	4	8GB	128GB SATA3 TLC (WT)	Option
AES-2020L-M8N12DP1	x6211E	2	2	2	4	4	8GB	128GB SATA3 TLC (WT)	12V/5A
AES-2020M-M8N12DP1	x6425E	2	2	2	4	4	8GB	128GB SATA3 TLC (WT)	12V/5A
AES-2020L-M0M00P0	X6211E	2	2	2	4	4	Option	Option	Option
AES-2020M-M0M00P0	X6425E	2	2	2	4	4	Option	Option	Option

Optional Items

Part Number	Description
SODIMM-DDR4- M8WT	204-Pin SODIMM DDR4-2133 8GB wide temperature(has been certified for -40°C ~ +85°C operation)
M2-N64DWT(2280)	M.2 SATA3 2280 64GB 3D-TLC wide temperature by B-KEY (has been certified for -40°C ~ +85°C operation)
M2-N12DWT(2280)	M.2 SATA3 2280 128GB 3D-TLC wide temperature by B-KEY (has been certified for -40°C ~ +85°C operation)
AC-9260	M.2 2230 (E-KEY) Wi-Fi Module, Intel AC9260 802.11abgn + Bluetooth 5.0, dual band 2T2R
DHAN3-60W-2P	AC-DC 60W Adapter, 90V-264Vac input by C14 socket, DC 12V@5A output with 2-pin phoneix connector
AES-WM-BK	AES Wall Mount Kits with Screws